National Semiconductor

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DS26LS31C/DS26LS31M
Quad High Speed Differential Line Driver

General Description

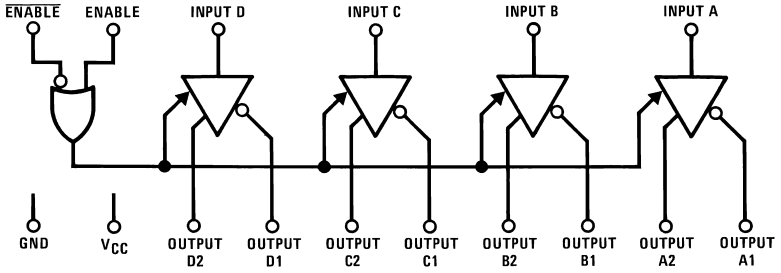
The DS26LS31 is a quad differential line driver designed for digital data transmission over balanced lines. The DS26LS31 meets all the requirements of EIA Standard RS-422 and Federal Standard 1020. It is designed to provide unipolar differential drive to twisted-pair or parallel-wire transmission lines.

The circuit provides an enable and disable function common to all four drivers. The DS26LS31 features TRI-STATE ® outputs and logically ANDed complementary outputs. The inputs are all LS compatible and are all one unit load.

Features

- Output skew—2.0 ns typical
- Input to output delay—10 ns typical
- Operation from single 5V supply
- Outputs won't load line when V_{CC} = 0V
- Four line drivers in one package for maximum package density
- Output short-circuit protection
- Complementary outputs
- Meets the requirements of EIA Standard RS-422
- Pin compatible with AM26LS31
- Available in military and commercial temperature range

Logic and Connection Diagrams



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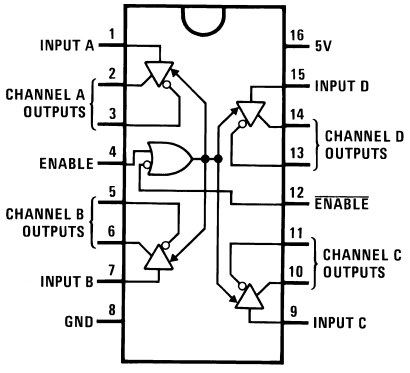
Dual-In-Line Package



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Top View
Order Number DS26LS31CM, or DS26LS31CN
See NS Package M16A or N16E
For Complete Military Product Specifications,
refer to the appropriate SMD or MDS.
Order Number DS26LS31MJ/883, DS26LS31ME/883 or DS26LS31MW/883
See NS Package E20A, J16A or W16A

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Absolute Maximum Ratings (Note 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage	7V
Input Voltage	7V
Output Voltage	5.5V
Output Voltage (Power OFF)	−0.25 to 6V
Maximum Power Dissipation (Note 1) at 25˚C	
Cavity Package	1509 mW
Molded DIP Package	1476 mW
SO Package	1051 mW

Operating Conditions

	Min	Max	Units
Supply Voltage, V_{CC}			
DS26LS31M	4.5	5.5	V
DS26LS31	4.75	5.25	V
Temperature, T_A			
DS26LS31M	−55	+125	˚C
DS26LS31	0	+70	˚C

Note 1: Derate cavity package 10.1 mW/˚C above 25˚C; derate molded DIP package 11.9 mW/˚C above 25˚C; derate SO package 8.41 mW/˚C above 25˚C.

Electrical Characteristics (Notes 3, 4, 5)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V_{OH}	Output High Voltage	I_{OH} = −20 mA	2.5			V
V_{OL}	Output Low Voltage	I_{OL} = 20 mA			0.5	V
V_{IH}	Input High Voltage		2.0			V
V_{IL}	Input Low Voltage				0.8	V
I_{IL}	Input Low Current	V_{IN} = 0.4V		−40	−200	µA
I_{IH}	Input High Current	V_{IN} = 2.7V			20	µA
I_I	Input Reverse Current	V_{IN} = 7V			0.1	mA
I_O	TRI-STATE Output Current	V_O = 2.5V			20	µA
		V_O = 0.5V			−20	µA
V_{CL}	Input Clamp Voltage	I_{IN} = −18 mA			−1.5	V
I_{SC}	Output Short-Circuit Current		−30		−150	mA
I_{CC}	Power Supply Current	All Outputs Disabled or Active		35	60	mA

Switching Characteristics

V_{CC} = 5V, T_A = 25˚C

Symbol	Parameter	Conditions	Min	Typ	Max	Units
t_{PLH}	Input to Output	C_L = 30 pF		10	15	ns
t_{PHL}	Input to Output	C_L = 30 pF		10	15	ns
Skew	Output to Output	C_L = 30 pF		2.0	6.0	ns
t_{LZ}	Enable to Output	C_L = 10 pF, S2 Open		15	35	ns
t_{HZ}	Enable to Output	C_L = 10 pF, S1 Open		15	25	ns
t_{ZL}	Enable to Output	C_L = 30 pF, S2 Open		20	30	ns
t_{ZH}	Enable to Output	C_L = 30 pF, S1 Open		20	30	ns

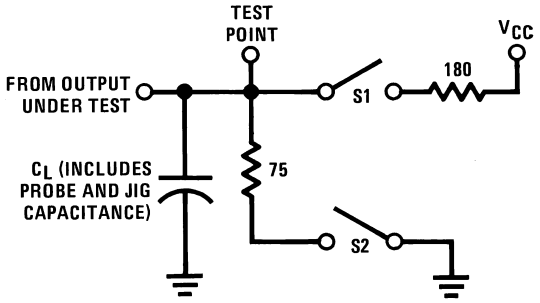
Note 2: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The tables of "Electrical Characteristics" provide conditions for actual device operation.

Note 3: Unless otherwise specified min/max limits apply across the −55˚C to +125˚C temperature range for the DS726LS31M and across the 0˚C to +70˚C range for the DS26LS31. All typicals are given for V_{CC} = 5V and T_A = 25˚C.

Note 4: All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to ground unless otherwise specified.

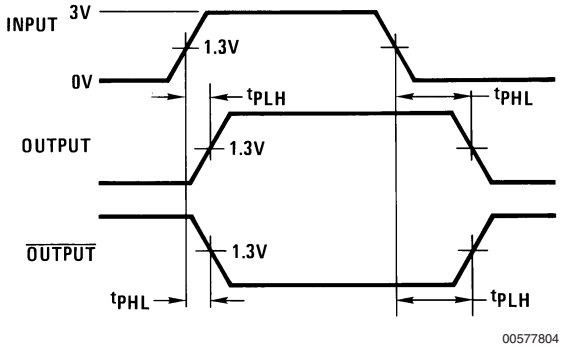
Note 5: Only one output at a time should be shorted.

AC Test Circuit and Switching Time Waveforms



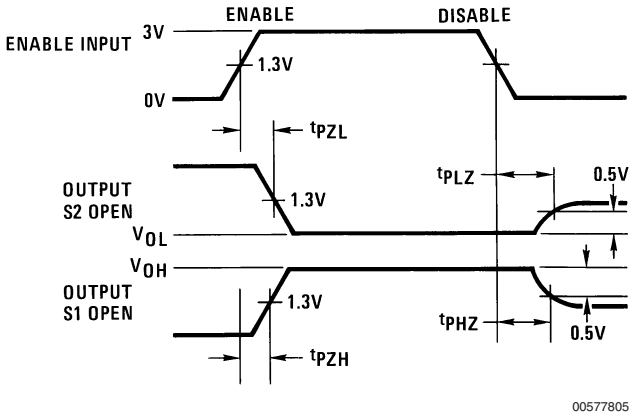
S1 and S2 of load circuit are closed except where shown.

FIGURE 1. AC Test Circuit



f = 1 MHz, $t_r \leq 15$ ns, $t_f \leq 6$ ns

FIGURE 2. Propagation Delays

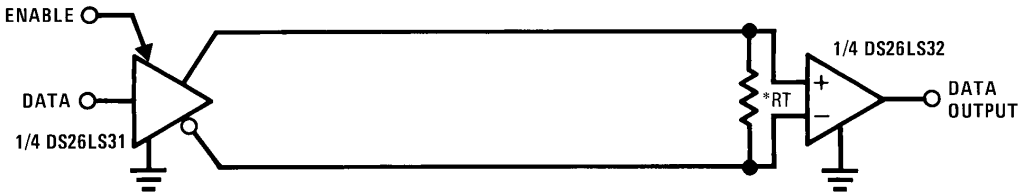


f = 1 MHz, $t_r \leq 15$ ns, $t_f \leq 6$ ns

FIGURE 3. Enable and Disable Times

Typical Applications

Two-Wire Balanced System, RS-422



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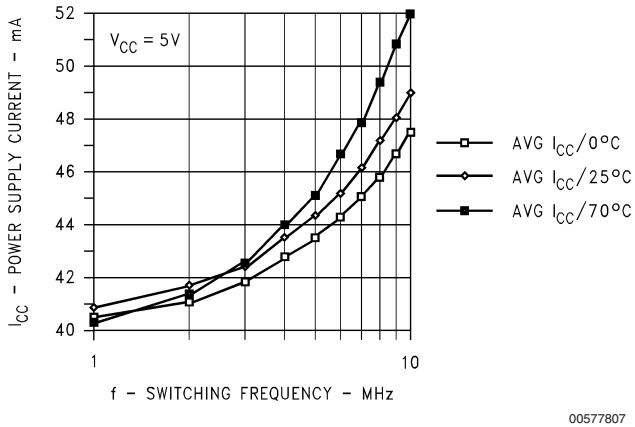
Note 6: R_T is optional although highly recommended to reduce reflection.

Typical Performance Characteristics

DS26LS31CN Unloaded I_C vs Frequency vs T_A



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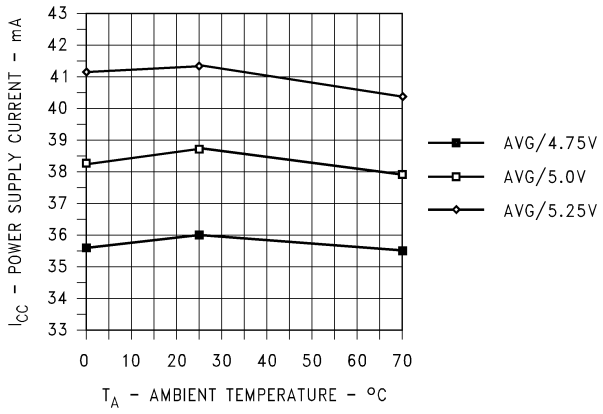
DS26LS31 I_{CC} vs V_{CC} vs T_A



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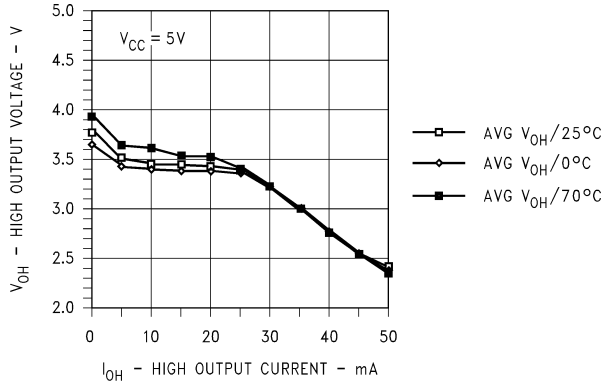
DS26LS31CN V_{OH} vs I_{OH} vs T_A



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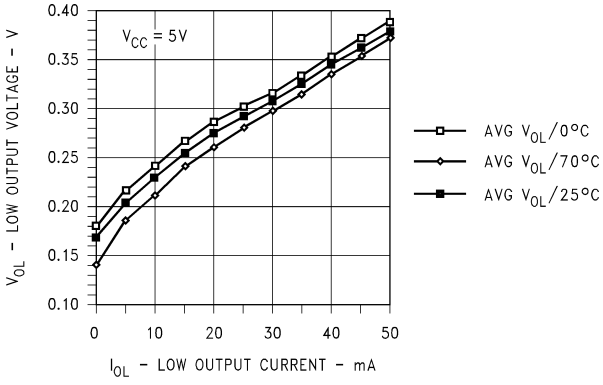
DS26LS31CN V_{OL} vs I_{OL} vs T_A



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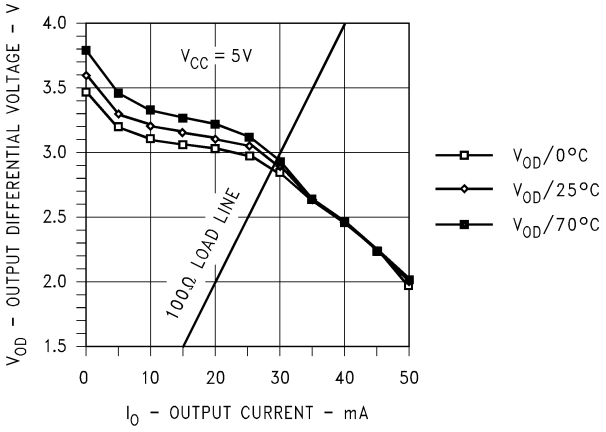
Typical Performance Characteristics (Continued)

DS26LS31CN V_{OD} vs I_O vs T_A



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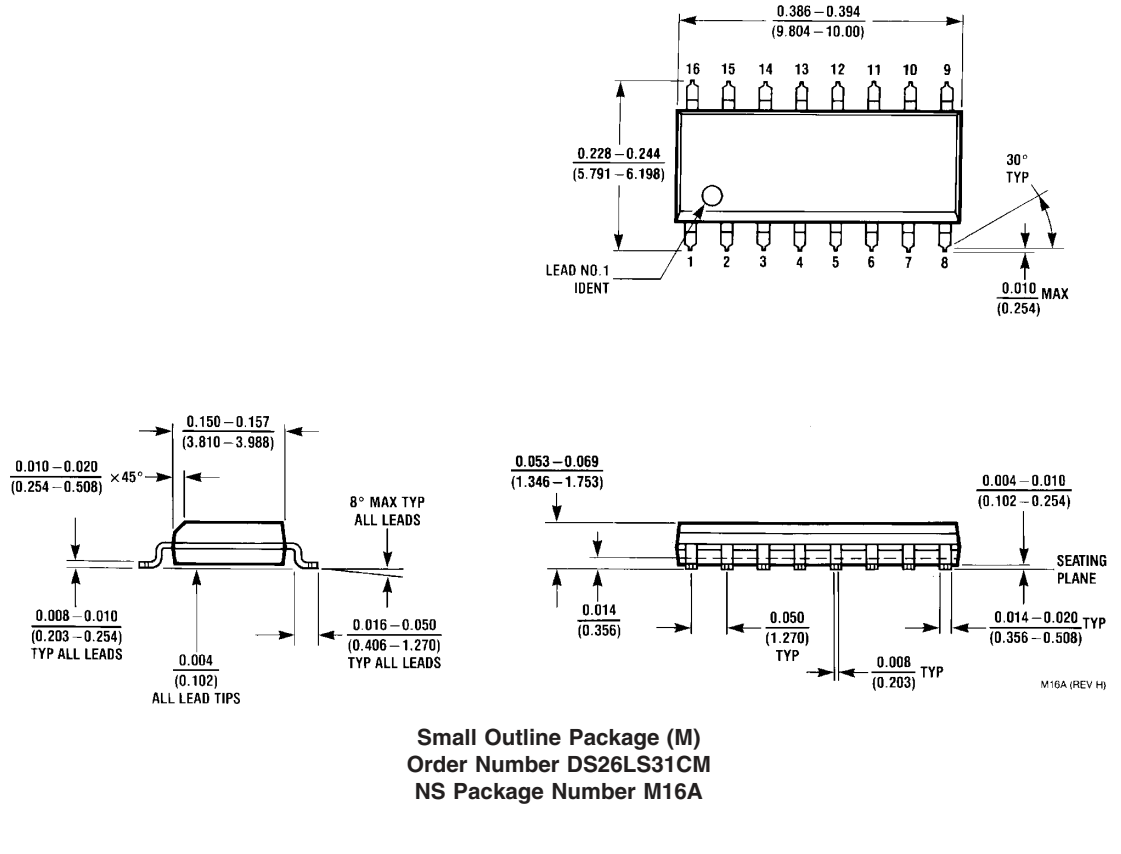
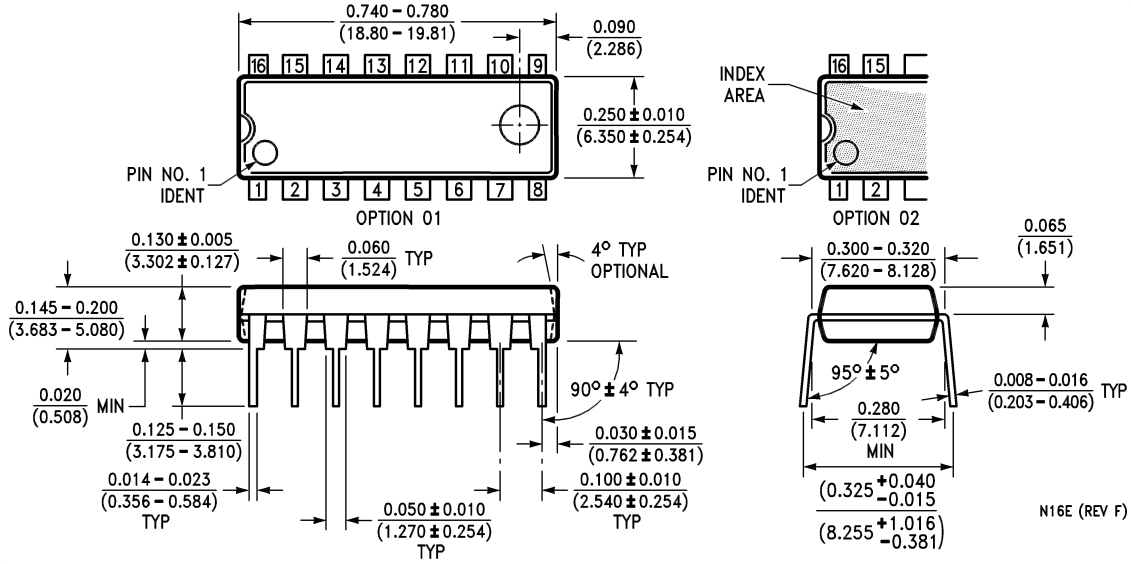
Physical Dimensions inches (millimeters)

unless otherwise noted

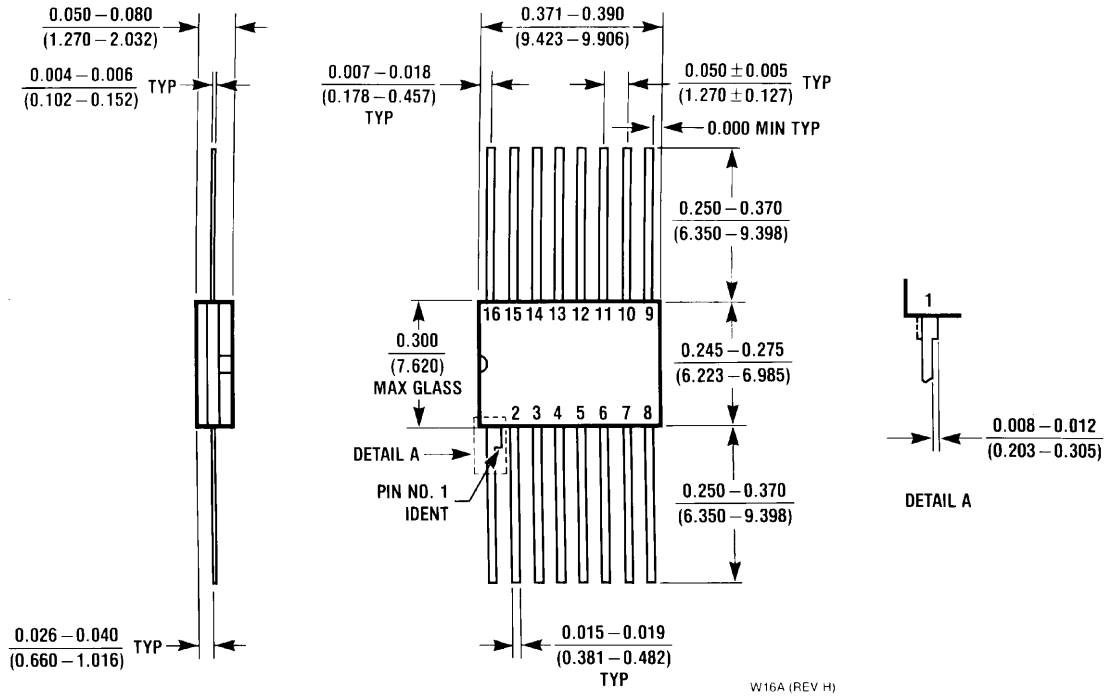


Small Outline Package (M)
Order Number DS26LS31CM
NS Package Number M16A

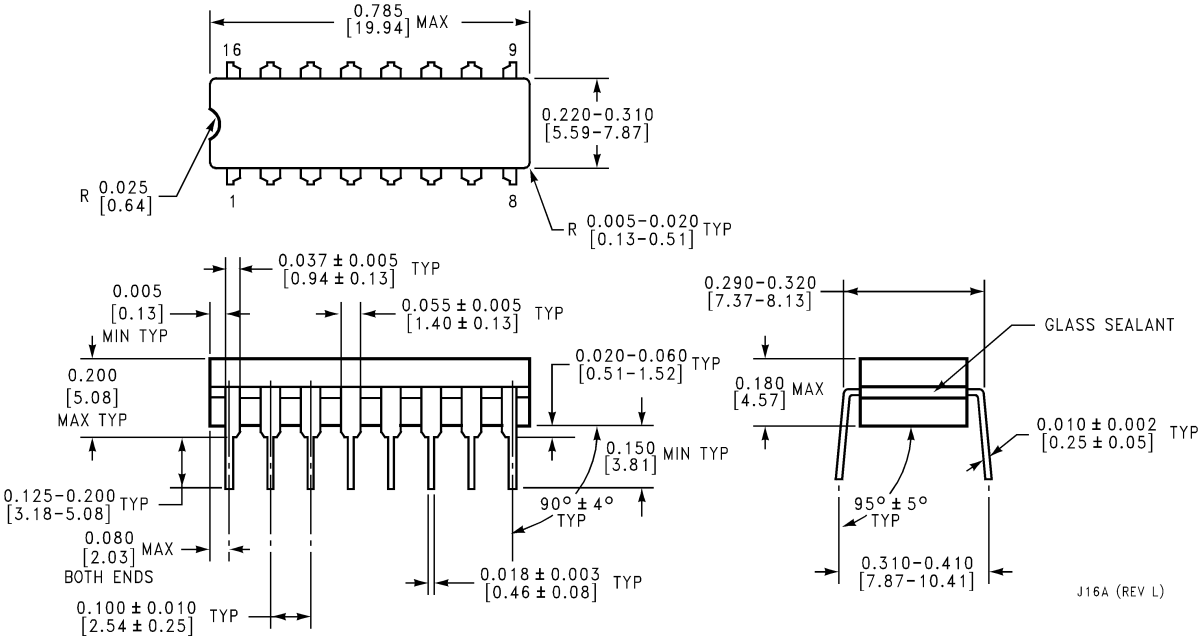


Molded Dual-In-Line Package (N)
Order Number DS26LS31CN
NS Package Number N16E

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

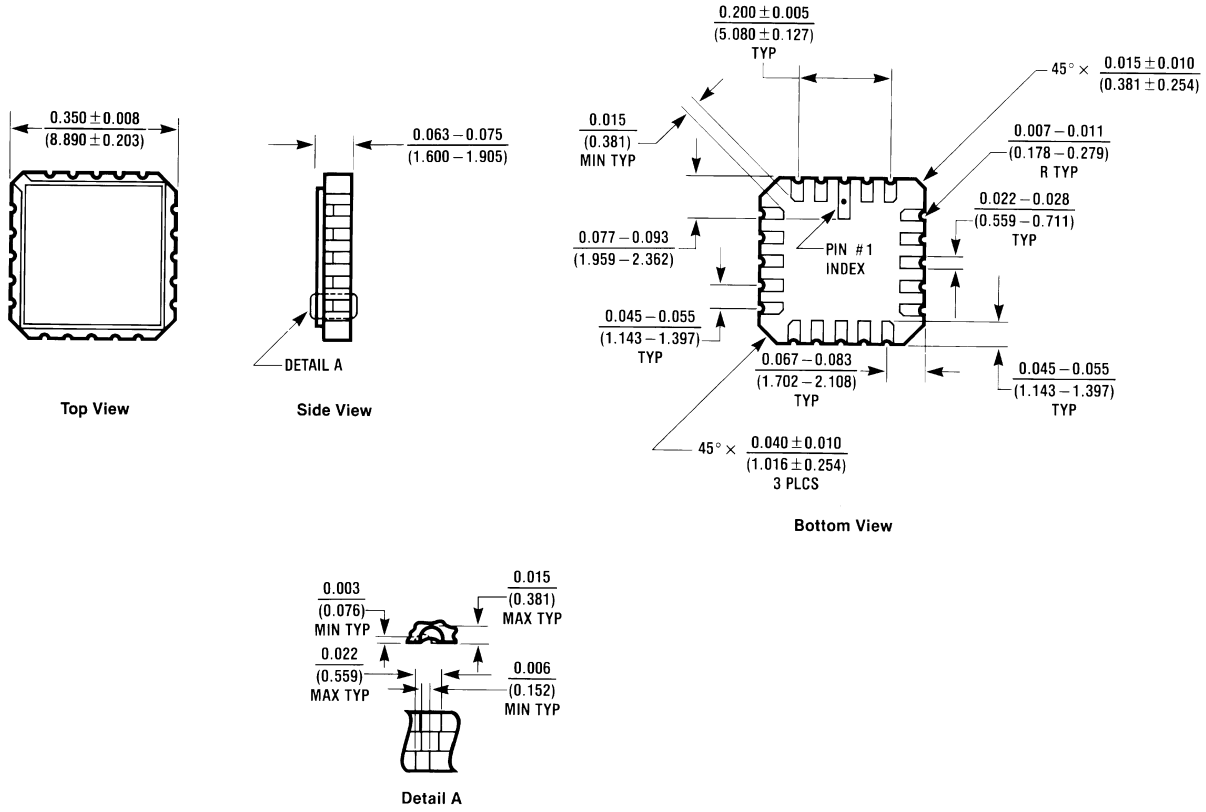


16 Lead Ceramic Flatpak (F)
Order Number DS26LS31MW/883
NS Package Number W16A



16 Lead Ceramic Dual-in-Line Package (J)
Order Number DS26LS31MJ/883
NS Package Number J16A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



E20A (REV D)

20 Lead Ceramic Leadless Chip Carrier (E)
Order Number DS26LS31MJE/883
NS Package Number E20A

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